

Bond-Ply® 100

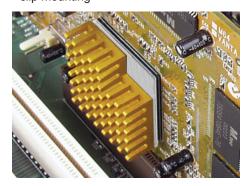
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PRODUCT DESCRIPTION

Thermally Conductive, Fiberglass Reinforced Pressure Sensitive Adhesive Tape

FEATURES AND BENEFITS

- Thermal impedance: 0.52°C-in²/W (@50 psi)
- · High bond strength to a variety of surfaces
- Double-sided, pressure sensitive adhesive tape
- High performance, thermally conductive acrylic adhesive
- Can be used instead of heat-cure adhesive, screw mounting or clip mounting



Shelf Life: The double-sided, pressure sensitive adhesive used in Bond-Ply® products requires the use of dual liners to protect the surfaces from contaminants. The recommended shelf life for Bergquist Bond-Ply® 100 is 6-months at a maximum continuous storage temperature of 35°C or 3-months at a maximum continuous storage temperature of 45°C, for maintenance of controlled adhesion to the liner. The shelf life of the Bond-Ply® material, without consideration of liner adhesion (which is often not critical for manual assembly processing), is recommended at 12 months from date of manufacture at a maximum continuous storage temperature of 60°C.

Note: To build a part number, visit our website at www.bergquistcompany.com.

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PROPERTY	PERTIES OF IMPERIAL VALUE		METRIC VALUE		TEST METHOD	
Color	White		White		Visual	
Reinforcement Carrier	Fiberglass		Fiberglass			
Thickness (inch) / (mm)	0.005, 0.008, 0.011		0.127, 0.203, 0.279		ASTM D374	
Temp. Resistance, 30 sec. (°F) / (°C)	392		200			
Elongation (%45° to Warp & Fill)	70		70		ASTM D412	
Tensile Strength (psi) / (MPa)	900		6		ASTM D412	
CTE (ppm)	325		325		ASTM D3386	
Glass Transition (°F) / (°C)	-22		-30		ASTM D1356	
Continuous Use Temp (°F) / (°C)	-22 to 248		-30 to 120		_	
ADHESION						
Lap Shear @ RT (psi) / (MPa)	100		0.7		ASTM D1002	
Lap Shear after 5 hr @ 100°C	200		1.4		ASTM D1002	
Lap Shear after 2 min @ 200°C	200		1.4		ASTM D1002	
Static Dead Weight Shear (°F) / (°C)	302		150		PSTC#7	
ELECTRICAL			VALUE		TEST METHOD	
Dielectric Breakdown Voltage - 0.005" (Vac)			3000		ASTM D149	
Dielectric Breakdown Voltage - 0.008" (Vac)			6000		ASTM D149	
Dielectric Breakdown Voltage - 0.011" (Vac)			8500		ASTM D149	
Flame Rating			V-O		U.L.94	
THERMAL						
Thermal Conductivity (W/m-K)			0.8		ASTM D5470	
THERMAL PERFORMANCE vs PR	ESSURE					
Initial Assembly Pressure (psi for 5	seconds)	10	25	50	100	200
TO-220 Thermal Performance (°C/W) 0.005"		5.17	4.87	4.49	4.18	4.10
TO-220 Thermal Performance (°C/W) 0.008"		5.40	5.35	5.28	5.22	5.20
TO-220 Thermal Performance (°C/W) 0.011"		6.59	6.51	6.51	6.50	6.40
Thermal Impedance (°C-in²/W) 0.005" (1)		0.56	0.54	0.52	0.50	0.50
Thermal Impedance (°C-in²/W) 0.008" (1)		0.82	0.80	0.78	0.77	0.75
Thermal Impedance (°C-in²/W) 0.011" (1)		1.03	1.02	1.01	1.00	0.99

1) The ASTM D5470 test fixture was used. The recorded value includes interfacial thermal resistance. These values are provided for reference only. Actual application performance is directly related to the surface roughness, flatness and pressure applied.

TYPICAL APPLICATIONS INCLUDE

- Mount heat sink onto BGA graphic processor or drive processor
- Mount heat spreader onto power converter PCB or onto motor control PCB

CONFIGURATIONS AVAILABLE

· Sheet form, roll form and die-cut parts



Disclaimer

Note:

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. The product can have a variety of different applications as well as differing application and working conditions in your environment that are beyond our control. Henkel is, therefore, not liable for the suitability of our product for the production processes and conditions in respect of which you use them, as well as the intended applications and results. We strongly recommend that you carry out your own prior trials to confirm such suitability of our product.

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Reference 0.1